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NAME OF CONVEYING PARTY:

Hidenori KIYOMI and
Shigeaki KIYOMI

NAME OF RECEIVING PARTY:

SEIEI CO., LTD.

ADDRESS OF RECEIVING PARTY:

4-3-1314, Manabigaoka 3-chome,
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NATURE OF CONVEYANCE:

Assignment of U.S. Patent Application

CONVEYANCE EXECUTION DATE:

February 18, 2010

PATENT APPLICATION NO.:

12/674,613

PATENT APPLICATION FILING DATE:

February 22, 2010

APPLICATION FILED TOGETHER
WITH THIS DOCUMENT:

NO

CORRESPONDENCE:
ADDRESS

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ATTORNEY REFERENCE:

KAS 106NP

TOTAL NUMBER OF PATENTS
AND APPLICATIONS INVOLVED:

One

TOTAL FEE PAID:

\$40.00

METHOD OF PAYMENT:

☒ Enclosed

Should the remittance be accidentally missing, the Director is hereby authorized to charge the fee to our Deposit Account No. 18-0002.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert H. Berdo, Jr.
Registration No. 38,075

March 31, 2011
Date

Total number of pages including cover sheet, attachments and document: 4.

PATENT
REEL: 026088 FRAME: 0361

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENTWHEREAS Hidenori KIYOMI and Shigeaki KIYOMI

hereinafter referred to collectively as the assignor, has invented a certain improvement relating to Molding Die and Molding Method, the specification of which was filed under the Patent Cooperation Treaty on August 13, 2008, Serial No. PCT/JP2008/64536, the United States of America being designated.

SEIEI CO., LTD

AND WHEREAS 4-3-1314, Manabigaoka 3-chome, Tarumi-ku, Kobe-shi, Hyogo 655-0004 JAPAN

hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof,

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

EXECUTED, this 18th day of February, 2010.**WITNESSES:**Signature: Sachiko MatsunoName: Sachiko MATSUNOAddress: 68, Hirano, Wadayama-cho,Asago-shi, Hyogo 669-5211 JAPAN**ASSIGNOR:**Signature Hidenori KiyomiName: Hidenori KIYOMI**ASSIGNOR:**Signature Shigeaki KiyomiName: Shigeaki KIYOMISignature: Tadaaki TanigakiName: Tadaaki TANIGAKIAddress: 3-10-8-401, Miyamaedaira,Miyamae-ku, Kawasaki-shi,Kanagawa 216-0006 JAPAN